## **CLAIMS**

What is claimed is:

- Y. A method for producing laminates for printed wiring boards using protective-carrier sheeting, the method comprising the steps of:
- (a) sandwiching a layer of protective-carrier sheeting between two layers of conductive foil extended from conductive-foil sources;
- (b) covering each of the conductive-foil layers with a dielectric layer to sandwich each conductive-foil layer between a dielectric layer and a layer of protective-carrier sheeting; and
- (c) repeating steps (a) and (b) and stacking the layers to form a book without use of adhesive or mechanical attachment between layers.
- 2. The method of claim 1, wherein the conductive foil comprises copper.
- 3. The method of claim 2, wherein the layer of protective-carrier sheeting has a thickness in the range from about 0.08 mm to about 0.5 mm.
- 4. The method of claim 3, wherein the layer of protective-carrier sheeting has a thickness in the range from 0.1 mm to 0.25 mm.
- 5. The method of claim 3, wherein the conductive-foil sources are rolls of copper foil.
- 6. The method of claim 5, wherein the dielectric layer comprises prepreg.
- 7. The method as recited in claim 5, further comprising the steps of:
  - (d) placing the book in a lamination press; and
- (e) pressing the book without inclusion of an adhesive or mechanical attachment between the protective-carrier sheeting and conductive foil.

- 8. The method of claim 3, wherein the protective-carrier sheeting comprises aluminum.
- 9. The method of claim 8, further comprising the step of unwinding the protective-carrier sheeting from a roll.
- 10. The method of claim 9, wherein the conductive foil and the protective-carrier sheeting are unwound from the same roll.
- 11. The method of claim 9, wherein the conductive foil and the protective-carrier sheeting are unwound from separate rolls.
- 12. The method of claim 8, wherein the protective-carrier sheeting is provided in the form of separate sheets.
- 13. A method for producing laminates for printed wiring boards using protective-carrier sheeting, the method comprising the steps of:
- (a) sandwiching a dielectric layer between two layers of conductive foil extended from conductive-foil sources;
- (b) covering at least one of the layers of conductive foil with a layer of protectivecarrier sheeting;
- (c) repeating steps (a) and (b) and stacking the layers to form a book, wherein each layer of conductive foil is sandwiched between a dielectric layer and a layer of protective-carrier sheeting without use of adhesive or mechanical attachment between layers.
- 14. The method of claim 13, wherein the conductive foil comprises copper.
- 15. The method of claim 14, wherein the layer of protective-carrier sheeting has a thickness in the range from about 0.08 mm to about 0.5 mm.

- 16. The method of claim 15, wherein the layer of protective-carrier sheeting has a thickness in the range from 0.1 mm to 0.25 mm.
- 17. The method of claim 15, wherein the conductive-foil sources comprise rolls of copper foil.
- 18. The method of claim 15, wherein the dielectric layer comprises prepreg.
- 19. The method as recited in claim 15, further comprising the steps of:
  - (d) placing the book in a lamination press; and
- (e) pressing the book without inclusion of an adhesive or mechanical attachment between the protective-carrier sheeting and conductive foil.
- 20. The method of claim 15, wherein the protective-carrier sheeting comprises aluminum.
- 21. The method of claim 20, further comprising the step of unwinding the protective-carrier sheeting from a roll.
- 22. The method of claim 21, wherein the conductive foil and the protective-carrier sheeting are unwound from the same roll.
- 23. The method of claim 21, wherein the conductive foil and the protective-carrier sheeting are unwound from separate rolls.
- 24. The method of claim 20, wherein the protective-carrier sheeting is provided in the form of separate sheets.